



Features:

- Supports 50GBASE-ER
- Lane signaling rate 26.5625 Gb/s with PAM4
- Up to 40KM transmission on SMF
- Cooled TOSA and APD ROSA
- I2C interface with integrated Digital Diagnostic monitoring
- QSFP28 MSA package with duplex LC connector
- Operating case temperature: 0 °C ~70 °C
- Maximum power consumption 4.5W
- RoHS compliant

Applications:

50GBASE-ER

Order Information

Table 1- order information

Part No.	Data Rate	Laser	Fiber Type	Distance	Optical Interface	Temp	DDMI
OPQG40	53.125Gbps	1310nm	SMF	40KM	LC	0~70C	Y

Absolute Maximum Ratings

Table 2-Absolute Maximum Ratings

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Storage Temperature	T _s	-40	-	+85	°C	
Supply Voltage	V _{cc}	-0.5	-	+4.0	V	
Operating Relative Humidity	RH	-	-	+85	%	

Recommended Operating Conditions

Table 3-Recommended Operating Conditions

Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Operating Case Temperature	T _c	0	-	+70	°C	
Power Supply Voltage	V _{cc}	3.13	3.3	3.47	V	
Power Supply Current	I _{cc}	-	-	1.3	A	
Maximum Power Dissipation	P _d	-	-	4.5	W	
Data Rate(optical)	DR _o	-	53.125	-	Gb/s	
Data Rate(Electrical)	DR _e	-	26.5625	-	Gb/s	
Transmission Distance	TD		-	40	km	Over SMF

Optical Characteristics

Table 4-Optical Characteristics

Transmitter						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Center Wavelength	CW	1304.5	1311	1317.5	nm	
Average Launch Power	P _{TX}	0.4	-	6.6	dBm	1
Outer Optical Modulation Amplitude	OMA	3.4	-	7.4	dBm	1
Launch power in OMA minus TDECQ(min)	OMA-TDECQ	2	-	-	dBm	
Transmitter and dispersion eye closure for PAM4 (TDECQ) (max)	TDECQ	-	-	3.2	dBm	
Average Output Power (Laser Turn off)	P _{OUT-OFF}	-	-	-30	dBm	
Side Mode Suppression Ratio	SMSR	30	-	-	dB	
Extinction Ratio	ER	6	-	-	dB	
RIN_OMA	RIN	-	-	-132	dB/Hz	
Transmitter reflectance	Tref	-	-	-26	dB	
Optical Return Loss Tolerance	ORLT	-	-	20	dB	
Receiver						
Center Wavelength	CW	1304.5	1311	1317.5	nm	
Damage threshold	P _{damage}	-6	-		dBm	
Average Rx Power	P _{RX}	-17.6	-	-7	dBm	2
Receive power_OMA	P _{OMA}	-	-	-2.6	dBm	2
Receiver sensitivity_OMA	SEN _{_OMA}	-	-	-15.1	dBm	2,3
Reflectance	Ref	-	-	-26	dB	
Stressed receiver sensitivity_OMA	SRS	-	-	-13.3	dBm	2,3
Conditions of stressed receiver sensitivity test						
Stressed eye closure for PAM4 (SECQ)	SECQ	-	-	3.2	dB	4

Notes:

1. The optical power is launched into SMF.
2. Receiver sensitivity(OMA), each lane(max) is informative. Measured with test pattern PRBS2^31-1.
3. Measured with a PRBS2^31-1 @26.5625G/s, BER≤2.4E-4.
4. These test conditions are for measuring stressed receiver sensitivity. They are not characteristics of the receiver.

Electrical Characteristics

High-Speed Signal: Compliant to CAUI-4 (IEEE 802.3bm Annex 83E)

Low-Speed Signal: Compliant to QSFP-8679.

Table 5-Electrical Characteristics

Transmitter (Module Input)						
Parameter	Symbol	Min.	Typical	Max.	Unit	Notes
Input Differential Impedance	R _{in}	-	100	-	Ohm	
Differential Data Input Amplitude	V _{IN,P-P}	80	-	900	mVpp	
Differential termination mismatch (max)	D-mismatch	-	-	10%		
DC common-mode input voltage		-0.3	-	2.8	V	

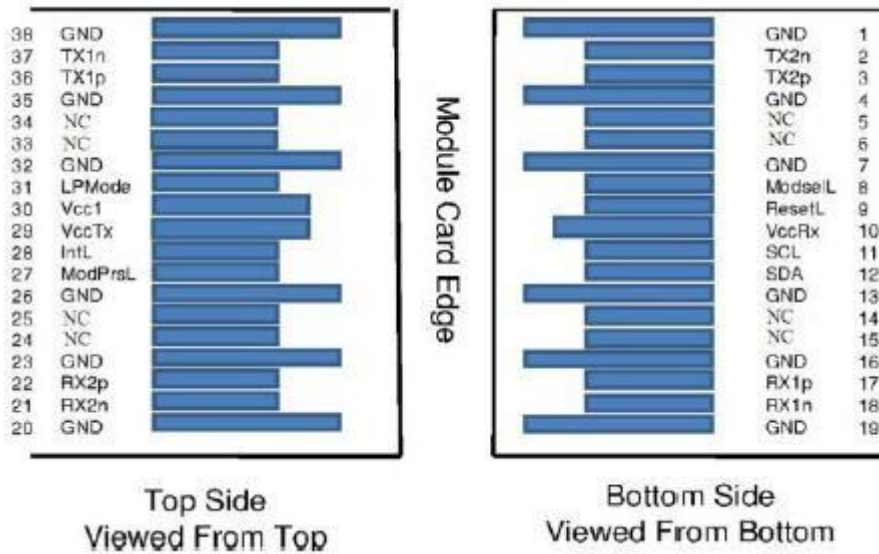
Transition time(20%~80%)	Tr Tf	10	-	-	ps	
LPMODE, Reset and ModSelL / Tx dis	V _{IL}	-0.3	-	0.8	V	
LPMODE, Reset and ModSelL / Tx dis	V _{IH}	2.0	-	V _{CC} +0.3	V	
Receiver (Module Output)						
Output Differential Impedance	R _{out}	-	100	-	Ohm	
Differential Data Output Amplitude	V _{OUT,P-P}	-	-	900	mVpp	
Differential termination mismatch (max)	D-mismatch	-	-	10	%	
Transition time, 20% to 80%	Tr Tf	12	-		ps	
ModPrsL and IntL/ Rx los	V _{OL}	0	-	0.4	V	
ModPrsL and IntL/ Rx los	V _{OH}	V _{CC} -0.5	-	V _{CC} +0.3	V	

Digital Diagnostics

Table 6-Digital Diagnostics

Parameter	Range	Accuracy	Unit	Calibration
Temperature	0 to 70	±3	°C	Internal
Voltage	0 to V _{CC}	0.1	V	Internal
Tx Bias Current	0 to 100	10%	mA	Internal
Tx Output Power	-4.5 to 4.2	±3	dBm	Internal
Rx Power	-10.8 to 4.2	±3	dBm	Internal

Pin Definitions



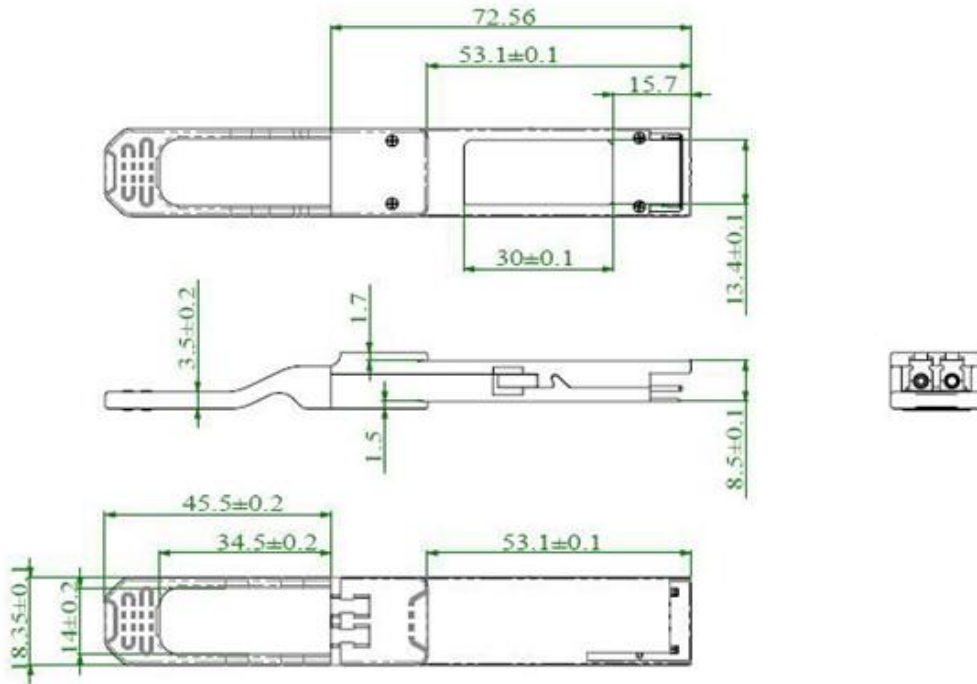
APD	Logic	Symbol	Description	Plug Seq.	Notes
1		GND	Ground	1	1
2	CML-I	Tx2n	Transmitter Inverted Data Input	3	
3	CML-I	Tx2p	Transmitter Non-Inverted Data output	3	
4		GND	Ground	1	1
5		NC		3	
6		NC		3	

7		GND	Ground	1	1
8	LVTLL-I	ModSelL	Module Select	3	
9	LVTLL-I	ResetL	Module Reset	3	
10		VccRx	+ 3.3V Power Supply Receiver	2	2
11	LVC MOS-I/O	SCL	2-Wire Serial Interface Clock	3	
12	LVC MOS-I/O	SDA	2-Wire Serial Interface Data	3	
13		GND	Ground	1	
14	Rev 03 2018-08	NC		3	
15		NC		3	
16		GND	Ground	1	1
17	CML-O	Rx1p	Receiver Non-Inverted Data Output	3	
18	DS-00055 CML-O	Rx1n	Receiver Inverted Data Output	3	
19		GND	Ground	1	1
20		GND	Ground	1	1
21	CML-O	Rx2n	Receiver Inverted Data Output	3	
22	CML-O	Rx2p	Receiver Non-Inverted Data Output	3	
23		GND	Ground	1	1
24		NC		3	
25		NC		3	
26		GND	Ground	1	1
27	LVTTL-O	ModPrsL	Module Present	3	
28	LVTTL-O	IntL	Interrupt	3	
29		VccTx	+3.3 V Power Supply transmitter	2	2
30		Vcc1	+3.3 V Power Supply	2	2
31	LVTTL-I	LPMode	Low Power Mode	3	
32		GND	Ground	1	1
33		NC		3	
34		NC		3	
35		GND	Ground	1	1
36	CML-I	Tx1p	Transmitter Non-Inverted Data Input	3	
37	CML-I	Tx1n	Transmitter Inverted Data Output	3	
38		GND	Ground	1	1

Note 1: GND is the symbol for signal and supply (power) common for the QSFP28 module. All are common within the QSFP28 module and all module voltages are referenced to this potential unless otherwise noted. Connect these directly to the host board signal-common ground plane.

Note 2: Vcc Rx, Vcc1 and Vcc Tx are the receiver and transmitter power supplies and shall be applied concurrently. Requirements defined for the host side of the Host Edge Card Connector are listed in MSA. The connector APDs are each rated for a maximum current of 1000 mA.

Mechanical Dimension



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